Electronic Acknowledgement Receipt

EFS ID:	1064589
Application Number:	10680664
Confirmation Number:	5418
Title of Invention:	Integrated circuit package bond pad having plurality of conductive members
First Named Inventor:	Yian-Liang Kuo
Customer Number:	42717
Filer:	David M. Odell/Bonnie Boyle
Filer Authorized By:	David M. Odell
Attorney Docket Number:	24061.43 (TSMC2002-0978)
Receipt Date:	01-JUN-2006
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Application Type:	Utility
International Application Number:	

Payment information:

Submitted with Payment	yes
Payment was successfully received in RAM	$500
RAM confirmation Number	281
Deposit Account	081394

File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages

1		43PreAppeal.pdf	274895	yes	6

Multipart Description		
Doc Desc	**Start**	**End**
Notice of Appeal Filed	1	1
Pre-Brief Conference request	2	6

Warnings:

Information:

2	Fee Worksheet (PTO-875)	fee-info.pdf	8171	no	2

Warnings:

Information:

Total Files Size (in bytes):	283066

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New Applications Under 35 U.S.C. 111
If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371
If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.